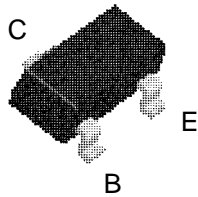


FSB660 / FSB660A



SuperSOT™-3 (SOT-23)

PNP Low Saturation Transistor

These devices are designed with high current gain and low saturation voltage with collector currents up to 2A continuous.

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	FSB660/FSB660A	Units
V _{CEO}	Collector-Emitter Voltage	60	V
V _{CB0}	Collector-Base Voltage	60	V
V _{EB0}	Emitter-Base Voltage	5	V
I _C	Collector Current - Continuous	2	A
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150°C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics T_A = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		FSB660/FSB660A	
P _D	Total Device Dissipation	500	mW
R _{θJA}	Thermal Resistance, Junction to Ambient	250	°C/W

PNP Low Saturation Transistor

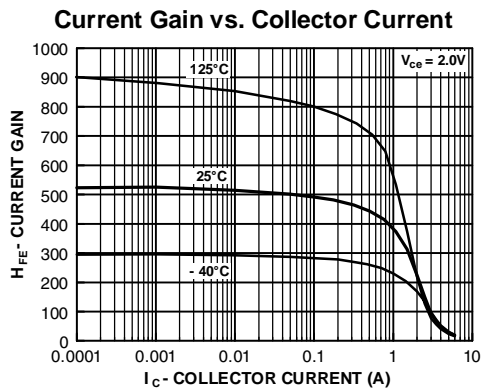
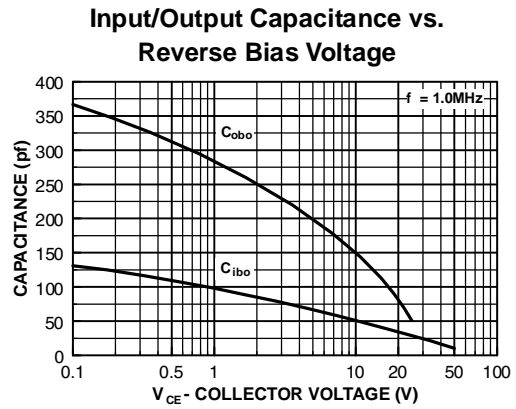
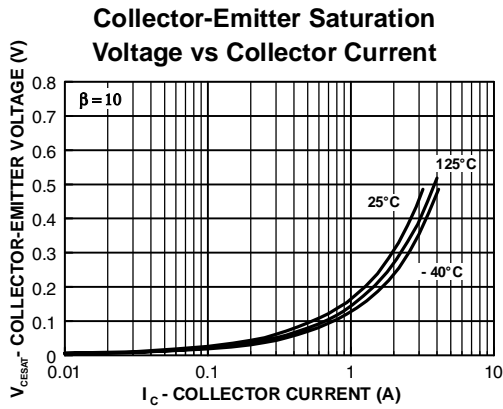
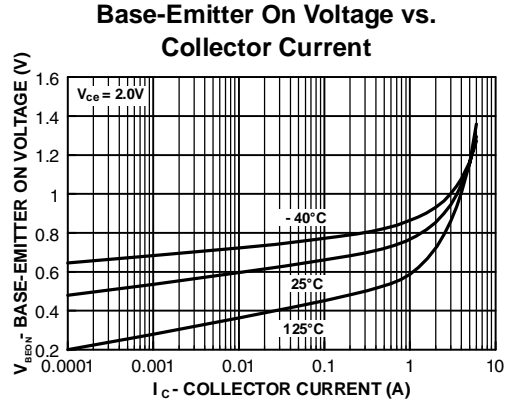
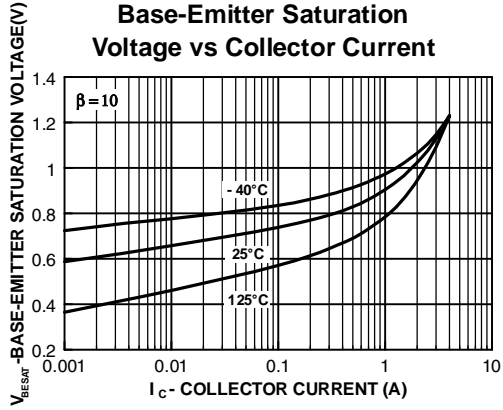
(continued)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHARACTERISTICS					
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10 \text{ mA}$	60		V
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu\text{A}$	60		V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = 100 \mu\text{A}$	5		V
I_{CBO}	Collector Cutoff Current	$V_{CB} = 30 \text{ V}$ $V_{CB} = 30 \text{ V}, T_A = 100^\circ\text{C}$		100 10	nA uA
I_{EBO}	Emitter Cutoff Current	$V_{EB} = 4\text{V}$		100	nA
ON CHARACTERISTICS*					
h_{FE}	DC Current Gain	$I_C = 100 \text{ mA}, V_{CE} = 2 \text{ V}$ $I_C = 500 \text{ mA}, V_{CE} = 2 \text{ V}$ FSB660 FSB660A $I_C = 1 \text{ A}, V_{CE} = 2 \text{ V}$ $I_C = 2 \text{ A}, V_{CE} = 2 \text{ V}$	70 100 250 80 40	300 550	-
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 1 \text{ A}, I_B = 100 \text{ mA}$ $I_C = 2 \text{ A}, I_B = 200 \text{ mA}$ FSB660 FSB660A		300 350 300	mV
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = 1 \text{ A}, I_B = 100 \text{ mA}$		1.25	V
$V_{BE(on)}$	Base-Emitter On Voltage	$I_C = 1 \text{ A}, V_{CE} = 2 \text{ V}$		1	V
SMALL SIGNAL CHARACTERISTICS					
C_{obo}	Output Capacitance	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		30	pF
f_T	Transition Frequency	$I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$	75		-

*Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$

Typical Characteristics



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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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